



MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

Table 1 Parameter

R_{DS(on),max}

Q_G (0V..10V)

 $V_{\rm DS}$

 I_{D}

Qoss

Qsw

- N-channel, normal level

Key Performance Parameters

Unit

V

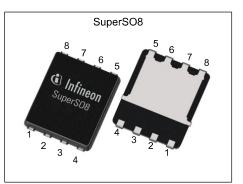
A

nC

nC

nC

mΩ



Drain Gate Pin 4 Source Pin 1-3 *1: Internal body diode





Type / Ordering Code	Package	Marking	Related Links
BSC110N15NS5	PG-TDSON-8	110N15NS	-

Excellent gate charge x R_{DS(on)} product (FOM) Very low on-resistance R_{DS(on)} 150 °C operating temperature Pb-free lead plating; RoHS compliant Qualified according to JEDEC¹⁾ for target application Ideal for high-frequency switching and synchronous rectification

Value

150

11

76

78

28

11.5

¹⁾ J-STD20 and JESD22 **Final Data Sheet**



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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

Demonstern	Oh. a l		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current	I _D	-	-	76 48	A	<i>T</i> _C =25 °C <i>T</i> _C =100 °C	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	304	A	<i>T</i> _c =25 °C	
Avalanche energy, single pulse ²⁾	EAS	-	-	100	mJ	I _D =50 A, R _{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	Ptot	-	-	125	W	<i>T</i> _c =25 °C	
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Demonster	Complete L	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.6	1	K/W	-
, 6 cm ² cooling area ³⁾	R _{thJA}	-	-	50	K/W	-

Electrical characteristics 3

at T_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Devenuestan	Course had		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA	
Gate threshold voltage	V _{GS(th)}	3	3.8	4.6	V	V _{DS} =V _{GS} , <i>I</i> _D =91 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	9 10	11 12.7	mΩ	V _{GS} =10 V, <i>I</i> _D =38 A, V _{GS} =8 V, <i>I</i> _D =19 A,	
Gate resistance ⁴⁾	R _G	-	0.9	1.35	Ω	-	
Transconductance	g fs	29	58	-	S	V _{DS} >2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =38 A	

¹⁾ See Diagram 3 for more detailed information
 ²⁾ See Diagram 13 for more detailed information
 ³⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection.

PCB is vertical in still air. ⁴⁾ Defined by design. Not subject to production test

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Table 5 **Dynamic characteristics**

Parameter	Symbol	Values			11	
		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	2080	2770	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	515	685	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	13	23	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	10.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	3.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{\rm d(off)}$	-	14.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	2.9	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol	Values			llmit	Note / Toot Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	12	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	5.8	9	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	11.5	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	28	35	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	5.8	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	78	103	nC	V _{DD} =75 V, V _{GS} =0 V

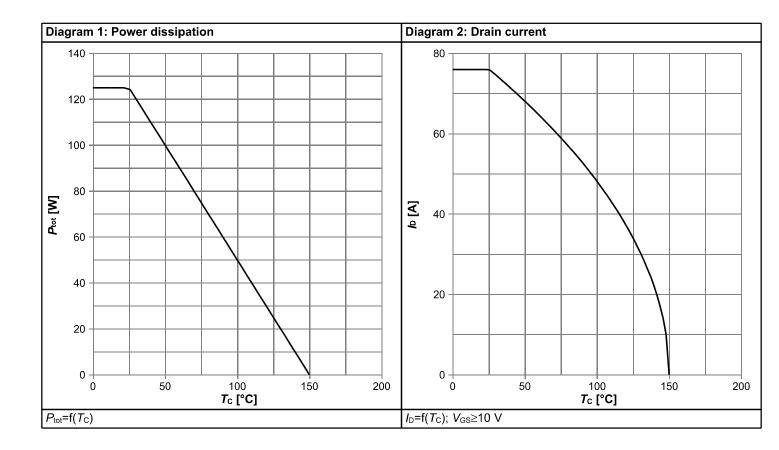
Reverse diode Table 7

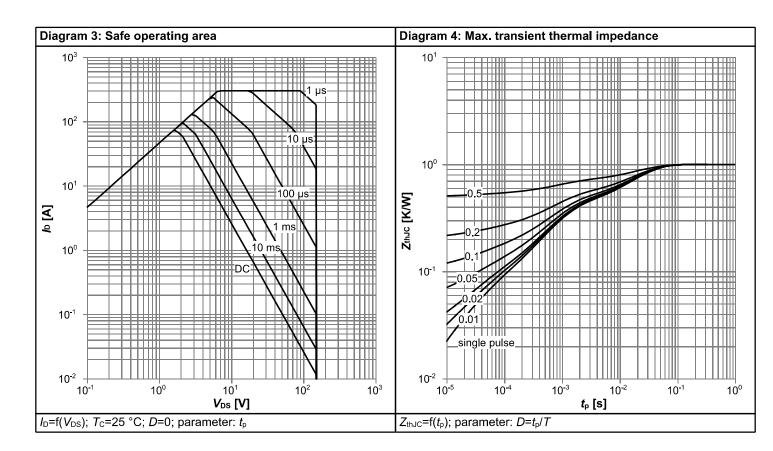
Parameter	C. maked		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	l _s	-	-	86	A	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	304	A	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1.2	V	V _{GS} =0 V, <i>I</i> _F =38 A, <i>T</i> _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	45	90	ns	V _R =75 V, <i>I</i> _F =38 A, d <i>i</i> _F /d <i>t</i> =100 A/µs
Reverse recovery charge ¹⁾	Q _{rr}	-	46	92	nC	V _R =75 V, <i>I</i> _F =38 A, d <i>i</i> _F /d <i>t</i> =100 A/µs

 $^{1)}$ Defined by design. Not subject to production test $^{2)}$ See "Gate charge waveforms" for parameter definition

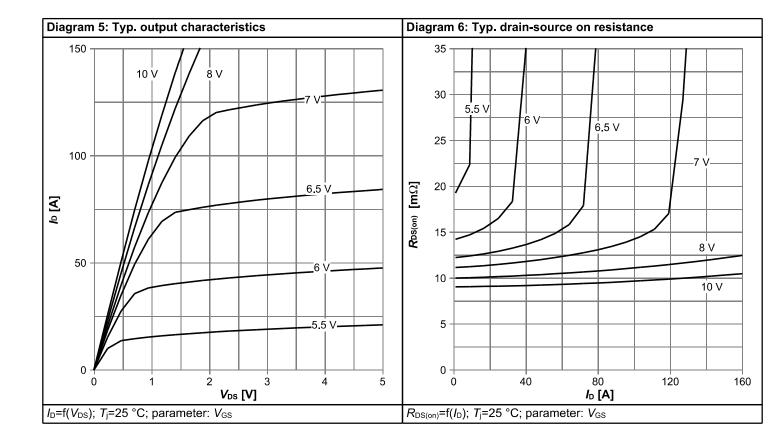


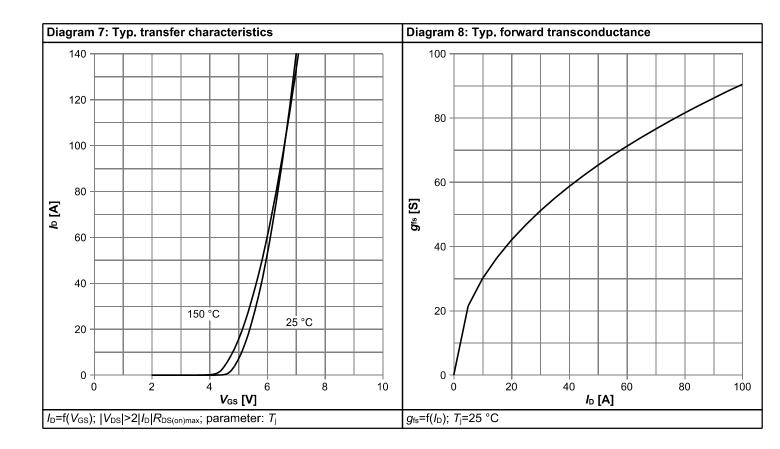
4 Electrical characteristics diagrams



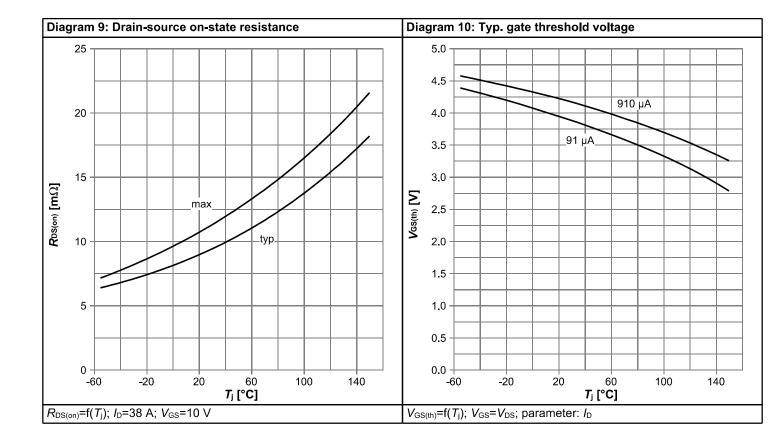


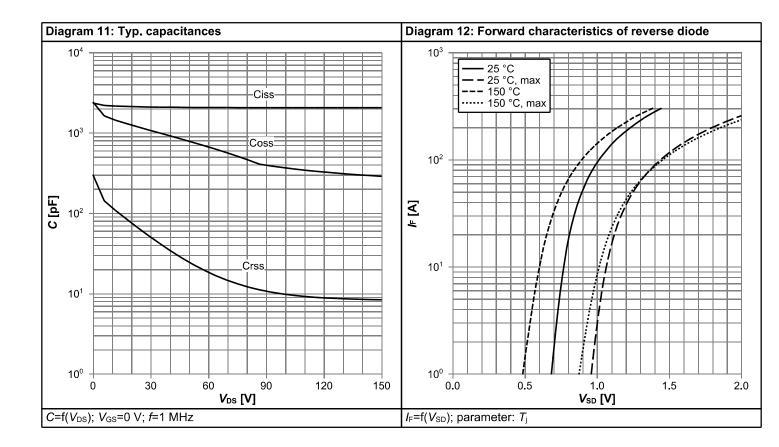




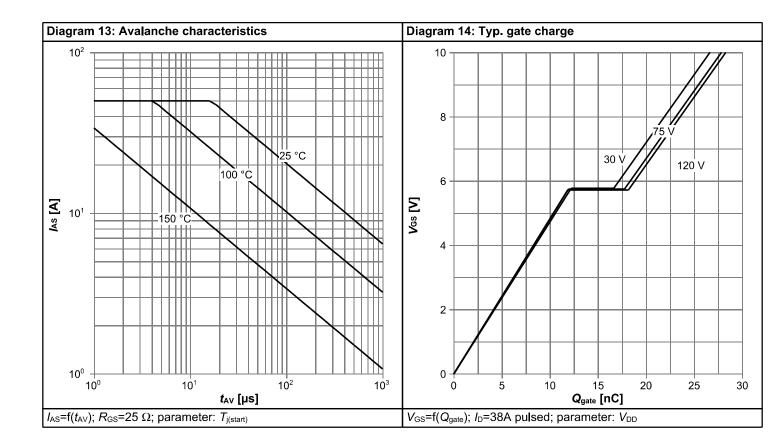


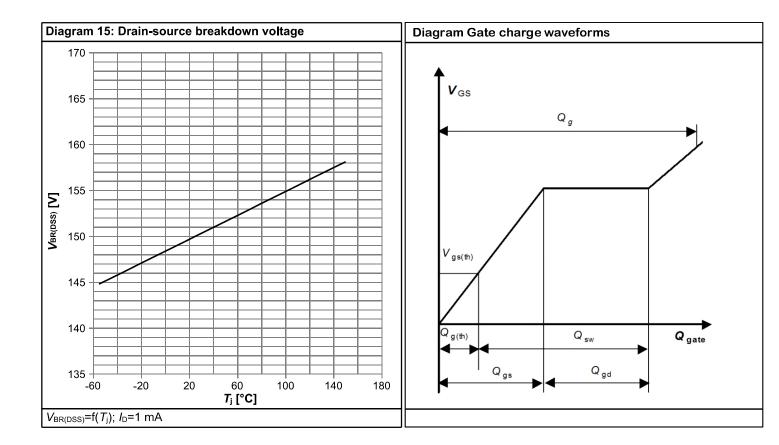






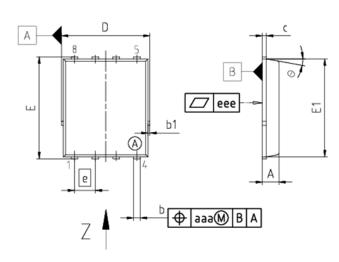


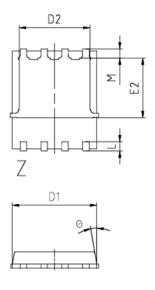






5 Package Outlines





	MILLIM	ETERS				
DIM	MIN	MAX				
Α	0.90	1.10				
b	0.31	0.54				
b1	0.02	0.22				
c	0.15	0.35				
D	5.15	5.49				
D1	4.95	5.35				
D2	3.70	4.40				
E	5.95	6.35				
E1	5.70	6.10				
E2	3.40	3.80				
е	1.27					
N	8					
L	0.45	0.71				
м	0.45	0.75				
Θ	8.5°	12°				
aaa	0.1	25				
eee	0.08					

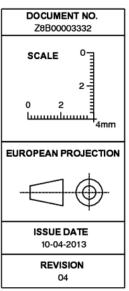


Figure 1 Outline PG-TDSON-8, dimensions in mm



Revision History

BSC110N15NS5

Revision: 2021-05-20, Rev. 2.5

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2015-05-26	Release of final version				
2.1	2015-06-09	Update Avalanche Energy				
2.2	2017-09-18	Update Ron max at Vgs=8V				
2.3	2018-02-21	Update labels Diagram 9				
2.4	2018-05-23	Update date				
2.5	2021-05-20	Update Diagram 11 and forward current				

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